

# STGP10NB60SFP

## 16 A, 600 V, low drop IGBT

### Features

- Low on-voltage drop (V<sub>CE(sat)</sub>)
- High current capability

## Applications

- Light dimmer
- Static relays
- Motor drive

## Description

This IGBT utilizes the advanced PowerMESH™ process featuring extremely low on-state voltage drop in low-frequency working conditions (up to 1 kHz).

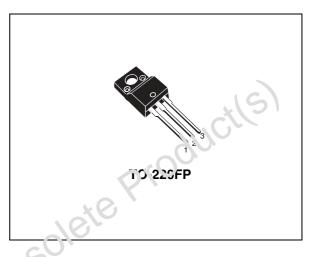
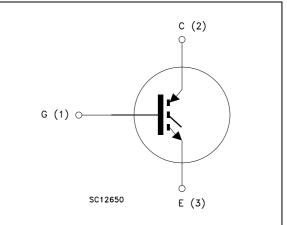


Figure 1. Internal schematic diagram



### Table 1. Device summary

	Order codes	Marking	Package	Packaging
ſ	STGP10NB60SFP	GP10NB60SFP	TO-220-FP	Tube

Doc ID 022312 Rev 1

# 1 Electrical ratings

Table 2.	Absolute	maximum	ratings
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Symbol	Parameter	Value	Unit
$V_{CES}$	Collector-emitter voltage (V <sub>GE</sub> = 0)	600	V
I <sub>C</sub> <sup>(1)</sup>	Continuous collector current at $T_{C} = 25 \ ^{\circ}C$	23	А
I <sub>C</sub> <sup>(1)</sup>	Continuous collector current at $T_{C} = 100 \ ^{\circ}C$	12	А
I <sub>CL</sub> <sup>(2)</sup>	Turn-off latching current	20	C A
I <sub>CP</sub> <sup>(3)</sup>	Pulsed collector current	80	Α
$V_{GE}$	Gate-emitter voltage	±2,\	V
V <sub>ISO</sub>	Isolation withstand voltage (RMS) from all three leads to external hea sink (t=1 s; $T_C = 25$ °C)	2500	V
P <sub>TOT</sub>	Total dissipation at $T_C = 25 \text{ °C}$	25	W
Тj	Operating junction temperature	– 55 to 150	°C

1. Calculated according to the iterative formula

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. Vclamp = 80% of V\_{CES} T\_j = 1:0 °C, R\_G=1k\Omega, V\_{GE}=15 V
- 3. Pulse width limit d by maximum junction temperature and turn-off within RBSOA

### Table : Thermal data

	Table 3			
10	iy.nbol	Parameter	Value	Unit
colle	R <sub>thj-case</sub>	Thermal resistance junction-case	5	°C/W
05	R <sub>thj-amb</sub>	Thermal resistance junction-ambient	62.5	°C/W
06				



# 2 Electrical characteristics

(T<sub>i</sub> =25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)CES</sub>	Collector-emitter breakdown voltage (V <sub>GE</sub> = 0)	I <sub>C</sub> = 250 μA	600			۷
V <sub>(BR)ECS</sub>	Emitter-collector breakdown voltage (V <sub>GE</sub> = 0)	I <sub>C</sub> = 1 mA	20			v
I <sub>GES</sub>	Gate-emitter leakage current (V <sub>CE</sub> = 0)	V <sub>GE</sub> = ±20 V		٠Č	<u></u> 100	nA
I <sub>CES</sub>	Collector cut-off current (V <sub>GE</sub> = 0)	V <sub>CE</sub> = 600 V V <sub>CE</sub> = 600 V, T <sub>j</sub> = 125 °C	90		10 100	μΑ μΑ
V <sub>GE(th)</sub>	Gate threshold voltage	V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 250 μA	2.5		5	V
V <sub>CE(sat)</sub>	Collector-emitter saturation voltage	$V_{GE}$ = 15 V, $I_{C}$ = 5 A $V_{GE}$ = 15 V, $I_{C}$ = 10 A $V_{GE}$ = 15 V, $I_{C}$ = 10 A, $T_{i}$ = 125 °C		1.15 1.35 1.25	1.75	V
$g_{fs}$ <sup>(1)</sup>	Forward transconductance	V <sub>CE</sub> = 15 V , I <sub>C</sub> = 10 A	5			S

1. Pulsed: Pulse duration = 300  $\mu \text{s}$ , du'y cycle 1.5%

### Table 5. Dynamic

	Symbo!	Parameter	Test conditions	Min.	Тур.	Max.	Unit
cole	C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>CE</sub> = 25 V, f = 1 MHz, V <sub>GE</sub> = 0	-	610 65 12	-	pF pF pF
0,02	Qg	Total gate charge	$V_{CE} = 400 \text{ V}, I_C = 10 \text{ A},$ $V_{GE} = 15 \text{ V}$ (see Figure 17)	-	33	-	nC



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 480 \text{ V}, I_C = 10 \text{ A}$ $R_G = 1 \text{ k}\Omega, V_{GE} = 15 \text{ V}$ (see Figure 16)	-	0.7 0.46 8	-	μs μs A/μs
t <sub>r</sub> (V <sub>off</sub> ) t <sub>d</sub> ( <sub>off</sub> ) t <sub>f</sub>	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 480 \text{ V}, \text{ I}_{C} = 10 \text{ A}$ $R_{G} = 1 \text{ k}\Omega, \text{ V}_{GE} = 15 \text{ V}$ (see Figure 16)	-	2.2 1.2 1.2	-	μs
t <sub>r</sub> (V <sub>off</sub> ) t <sub>d</sub> ( <sub>off</sub> ) t <sub>f</sub>	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 480 \text{ V}, I_C = 10 \text{ A}$ $R_G = 1 \text{ k}\Omega, V_{GE} = 15 \text{ V},$ $T_j = 125 \text{ °C}$ <i>(see Figure 16)</i>	-	3.8 1.2 1.9	9	μs
Table 7.     Switching energy (inductive load)						
Symbol	Parameter	Test conditions	Min.	Tvp.	Max.	Unit

Switching on/off (inductive load) Table 6.

Table 7.	Switching energy	(inductive load	d)
	•	(	~,

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon <sup>(1)</sup> E <sub>off</sub> <sup>(2)</sup> E <sub>ts</sub>	Turn-on switching losses Turn-off switching losses Total switching losses	V <sub>CC</sub> = 480 V I <sub>C</sub> = 10 A R <sub>G</sub> = 1 I <sub>2</sub> , V <sub>GE</sub> = 15 V (see <i>Figure 16</i> )	-	0.6 5 5.6	-	μJ μJ μJ
E <sub>off</sub> <sup>(2)</sup>	Turn-off switching losses	$V_{CC} = 480 \text{ V}, I_C = 10 \text{ A}$ $R_G = 1 \text{ k}\Omega, V_{GE} = 15 \text{ V},$ $T_j = 125 \text{ °C}$ <i>(see Figure 16)</i>	-	8	-	μJ

1. Eon is the turn-on los is when a typical diode is used in the test circuit. If the IGBT is offered in a package with a co-pack divor, the co-pack diode is used as external diode. IGBTs and diode are at the same temperature (24 °C and 125°C).

2. Turn-off losces include also the tail of the collector current. obsolete



GC77810

lc=10A

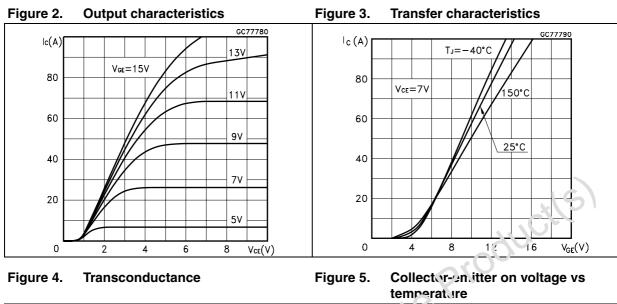
lc=7A

lc=3A

150

T」(℃)

## 2.1 Electrical characteristics (curves)



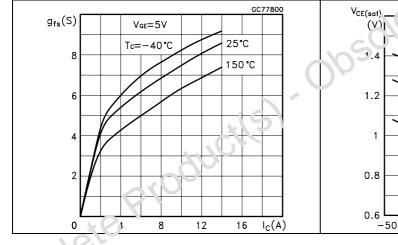
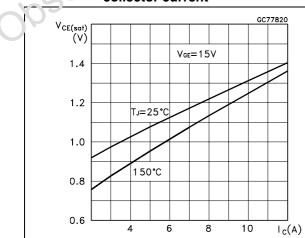
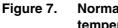


Figure 5. Collector-emitter on voltage vs collector current





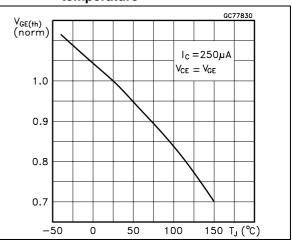
0

Normalized gate threshold vs temperature

100

50

 $V_{GE} = 15V$ 





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Qg(nC)

# Figure 8. Normalized breakdown voltage vs Figure 9. Gate charge vs gate-emitter voltage temperature

 $V_{GE}\left(V
ight)$ 

16

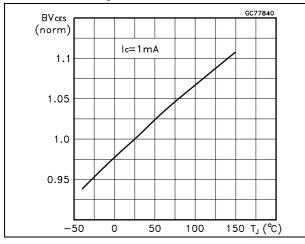
12

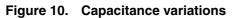
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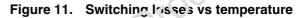
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20

**2**₹.

12

V<sub>CE</sub> = 480V

 $I_{C} = 10A$ 

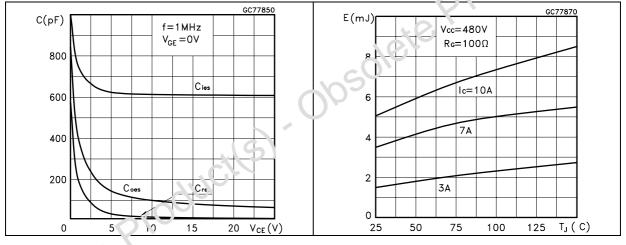
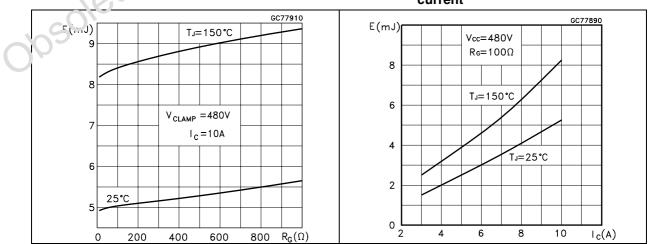


Figure 12. Syntching losses vs gate resistance Figure 13. Switching losses vs collector current





## Figure 14. Thermal impedance Figure 15. Turn-off SOA Ic(A) TOFPDE $V_{ge} = 15V$ k $\delta = 0.5$ 25 $R_{G} = 1 K \Omega$ \_\_\_ 0.2 TJ=125℃ TT. 0.1 20 10 0.05 15 \_\_\_\_ 0.01 $Z_{th} = k R_{thJ-c}$ $\delta=\,{\rm t_p}\,/\tau$ 10 10 SINGLE PULSE obsolete Product(s).



\_\_\_\_V cc

1KΩ

۷<sub>G</sub>

#### **Test circuits** 3

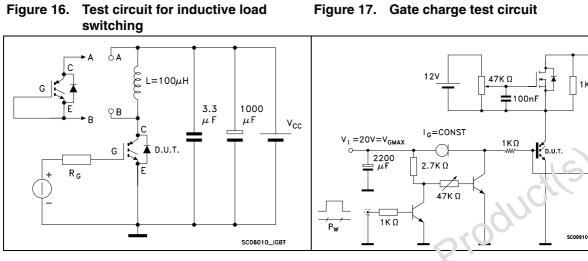
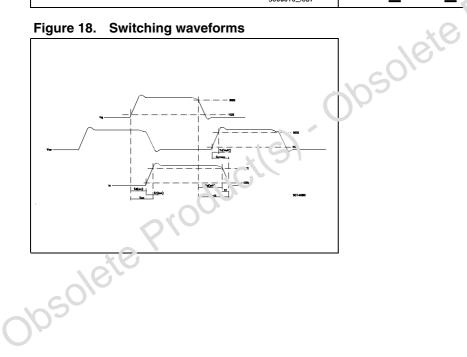


Figure 18. Switching waveforms



## 4 Package mechanical data

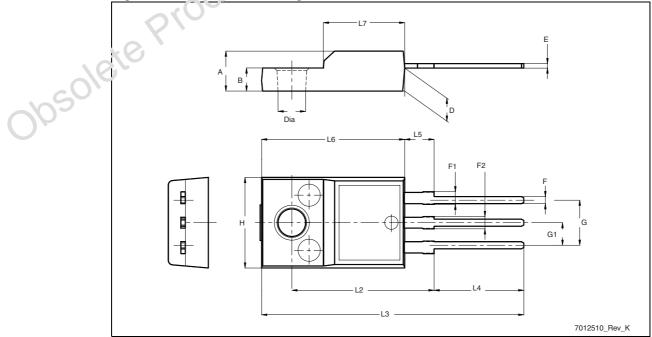
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.



obsolete Product(s). Obsolete Product(s)

Dim.		mm	
Dim.	Min.	Тур.	Max.
A	4.4		4.6
В	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10	0	10.4
L2		16	
L3	28.6	181	30.6
L4	9.8	601	10.6
L5	2.9	<u>10-</u>	3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

### Figure 19. TC-2?&?P drawing



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## 5 Revision history

Table 9.Document revision history

Date	Revision	Changes
03-Oct-2011	1	New release.



obsolete Product(s). Obsolete Product(s)

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